

Size  $6.1 \times 5.6 \times 4.9$  (mm)

Series/Type: B82471A1

Date: March 2008



B82471A1

#### Size $6.1 \times 5.6 \times 4.9$ (mm)

#### **SMD**

# Rated inductance 10 $\mu$ H to 220 $\mu$ H Rated current 0.35 A to 1.44 A

#### Construction

- Ferrite core
- Winding: enamel copper wire
- Winding soldered to terminals
- Plastic terminal carrier

#### **Features**

- Temperature range up to 150 °C
- High rated current
- Low DC resistance
- Suitable for lead-free reflow soldering as referenced in JEDEC J-STD 020C
- Qualification based on AEC-Q200
- RoHS-compatible

#### **Applications**

- Filtering of supply voltages
- Coupling, decoupling
- DC/DC converters
- Automotive electronics
- Industrial electronics
- Consumer electronics

#### **Terminals**

- Base material CuSn6P
- Layer composition Ni-Sn (lead-free)
- Electro-plated

#### Marking

- Marking on component:
  L value (μH, coded),
  manufacturing date (YWWD)
- Minimum data on reel:
  Manufacturer, ordering code,
  L value, quantity, date of packing

# Delivery mode and packing unit

- 16-mm blister tape, wound on 330-mm Ø reel
- Packing unit: 1000 pcs./reel



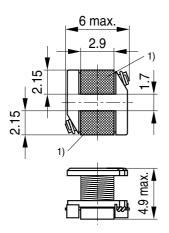


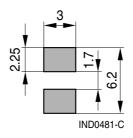
B82471A1

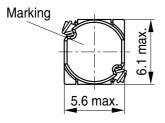
# Size $6.1 \times 5.6 \times 4.9$ (mm)

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# Dimensional drawing and layout recommendation







1) Soldering area

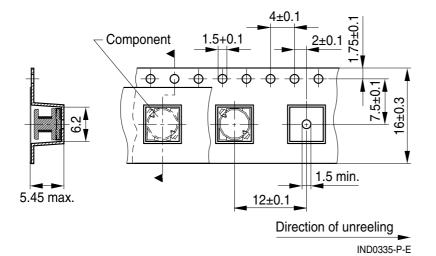
IND0480-Z-E

#### Dimensions in mm

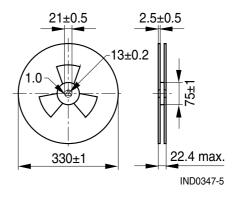
Component tolerances  $\pm 0.2$  mm unless otherwise noted.

# Taping and packing

# Blister tape



Reel



Dimensions in mm



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# Technical data and measuring conditions

Rated inductance L <sub>R</sub>	Measured with LCR meter Agilent 4284A at frequency $f_L$ , 0.1 V, 20 °C			
Rated temperature T <sub>R</sub>	85 °C			
Rated current I <sub>R</sub>	Max. permissible DC with temperature increase of $\leq$ 40 K at rated temperature			
Saturation current I <sub>sat</sub>	Max. permissible DC with inductance decrease $\Delta L/L_0$ of approx. 10%			
DC resistance R <sub>max</sub>	Measured at 20 °C			
Solderability (lead-free)	Dip and look method Sn95.5Ag3.8Cu0.7: $(245 \pm 5)$ °C, $(5 \pm 0.3)$ s Wetting of soldering area $\geq 90\%$ (based on IEC 60068-2-58)			
Resistance to soldering heat	260 °C, 40 s as referenced in JEDEC J-STD 020C			
Climatic category	55/150/56 (to IEC 60068-1)			
Storage conditions	Mounted: −55 °C +150 °C Packaged: −25 °C +40 °C, ≤ 75% RH			
Weight	Approx. 1 g			

# **Characteristics and ordering codes**

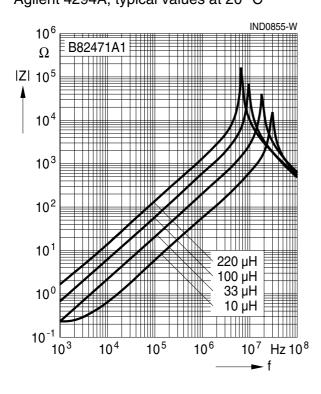
L <sub>R</sub>	Tolerance	$f_{L}$	I <sub>R</sub>	I <sub>sat</sub>	R <sub>max</sub>	Ordering code
μΗ		MHz	Α	Α	Ω	
10	±20% ≙ M	0.1	1.44	1.80	0.10	B82471A1103M000
15		0.1	1.30	1.45	0.14	B82471A1153M000
22		0.1	1.11	1.20	0.18	B82471A1223M000
33		0.1	0.88	1.00	0.23	B82471A1333M000
47		0.1	0.72	0.85	0.37	B82471A1473M000
68	±10% ≙ K	0.1	0.61	0.70	0.46	B82471A1683K000
100		0.1	0.52	0.60	0.70	B82471A1104K000
150		0.1	0.40	0.48	1.10	B82471A1154K000
220		0.1	0.35	0.38	1.57	B82471A1224K000

Sample kit available. Ordering code: B8247XX001 For more information refer to chapter "Sample kits".

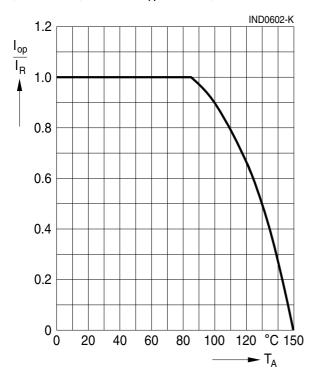


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# Impedance IZI versus frequency f measured with impedance analyzer Agilent 4294A, typical values at 20 °C

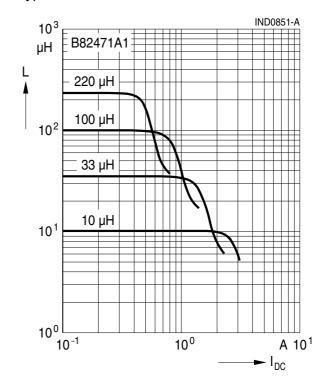


# Current derating $I_{op}/I_R$ versus ambient temperature $T_A$ (rated temperature $T_R = 85$ °C)



# **SMD**

# Inductance L versus DC load current I<sub>DC</sub> measured with LCR meter Agilent 4284A, typical values at 20 °C





### **Cautions and warnings**

- Please note the recommendations in our Inductors data book (latest edition) and in the data sheets.
  - Particular attention should be paid to the derating curves given there.
  - The soldering conditions should also be observed. Temperatures quoted in relation to wave soldering refer to the pin, not the housing.
- If the components are to be washed varnished it is necessary to check whether the washing varnish agent that is used has a negative effect on the wire insulation, any plastics that are used, or on glued joints. In particular, it is possible for washing varnish agent residues to have a negative effect in the long-term on wire insulation.
- The following points must be observed if the components are potted in customer applications:
  - Many potting materials shrink as they harden. They therefore exert a pressure on the plastic housing or core. This pressure can have a deleterious effect on electrical properties, and in extreme cases can damage the core or plastic housing mechanically.
  - It is necessary to check whether the potting material used attacks or destroys the wire insulation, plastics or glue.
  - The effect of the potting material can change the high-frequency behaviour of the components.
- Ferrites are sensitive to direct impact. This can cause the core material to flake, or lead to breakage of the core.
- Even for customer-specific products, conclusive validation of the component in the circuit can only be carried out by the customer.



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